



Click [here](#) for the 3D model.

Dimensions

Footprint	2513
L	2.54mm +/-0.38mm
W	1.27mm +/-0.38mm
H	1.27mm +/-0.38mm
S	0.76mm +0.25/-0.13mm
F	1.27mm +/-0.13mm
K	0.76mm MIN
P	0.38mm MIN

Packaging Specifications

Packaging	T&R, 178mm
Packaging Quantity	2500

General Information

Series	T409 CWR09
Dielectric	MnO ₂ Tantalum
Style	SMD Chip
Description	SMD, MnO ₂ , Molded, Military Equivalent
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov .
SCIP Number	656db0b8-8445-4117-82f2-2f12e764f0b1
Termination	Solder Fused
Qualifications	MIL-PRF-55365/4, CWR09 Style
AEC-Q200	No
Component Weight	39.91 mg
Notes	Note: When Option C Is Selected For Lead Material, Add An Additional 0.38mm To The Tolerances For "L", "W", "H", "K", "F" And "S".
MSL	1

Specifications

Capacitance	1 uF
Capacitance Tolerance	10%
Voltage DC	10 VDC (85C), 6.7 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	85°C
Dissipation Factor	6% 120Hz 25C
Failure Rate	B (0.1%/1000 Hrs)
Resistance	10 Ohms (100kHz 25C)
Leakage Current	1 uA (5min 25°C)
Testing and Reliability	Standard Testing Only

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)